TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7USB31WBG

Dual SPST USB Switch

TC7USB31 is high-speed CMOS dual SPST USB Switch. The low ON- resistance and the low capacitance of the switch allow connections to USB application.

The TC7USB31 requires the output enable (\overline{OE}) input to be set high to place the output into the high impedance.

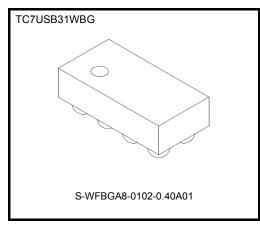
All inputs are equipped with protection circuits against static discharge.

Features

- Operating voltage: VCC = 2.3 to 3.6 V
- ON-capacitance: C_{I/O} = 5.5pF Switch ON(typ.) @V_{CC}=3.3V
- ON-resistance: $R_{ON} = 4.5 \Omega$ (typ.) @V_{CC}=3 V, $V_{I/O}$ =0 V
- Ron Flatness: $Ron(flat) = 1.2 \Omega (typ.) @VCC = 3 V$
- Delta Ron: $\Delta R_{\rm ON} = 0.5~\Omega$ (typ.) @V_{CC}=3 V
- ESD performance: Machine model ≥ ± 200V

Human body model $\geq \pm 2000V$

- Power-down protection for inputs (OE and I/O)
- Package: WCSP8

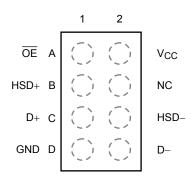


Weight

S-WFBGA8-0102-0.40A01 : 0.0017 g (typ)

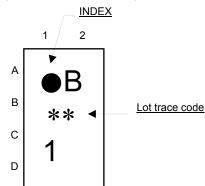
Pin Assignment (top view)

WBG (S-WFBGA8-0102-0.40A01)



Marking

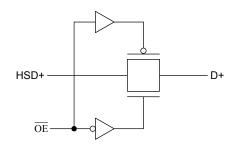
WBG (S-WFBGA8-0102-0.40A01)

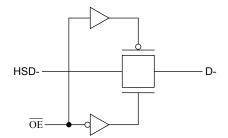


Truth Table

Inputs	Function			
ŌĒ	- Function			
L	A port = B port			
Н	Disconnect			

System Diagram





Absolute Maximum Ratings (Note)

Charact	eristic	Symbol	Rating	Unit	
Power supply range		V _{CC}	−0.5 to 4.6	V	
Control pin input voltage	(\overline{OE})	V _{IN}	−0.5 to 4.6	V	
Switch terminal I/O voltage	V _{CC} =0V or Switch=Off	Vs	−0.5 to 4.6	٧	
Switch terminal I/O voltage	Switch=On	VS	-0.5 to V _{CC} +0.5		
Clump diode current	Control input	luz	-50	mA	
	Switch	lik	±50		
Switch I/O current		IS	50	mA	
Power dissipation		PD	120	mW	
DC V _{CC} /GND current		I _{CC} /I _{GND}	±100	mA	
Storage temperature		T _{stg}	-65 to 150	°C	

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction. Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Chara	cteristic	Symbol	Rating	Unit	
Power supply voltage		V _{CC}	2.3 to 3.6	V	
Control pin input voltage	(\overline{OE})	V _{IN}	0 to 3.6	V	
Switch I/O voltage	V _{CC} =0V or Switch=Off	\/-	0 to 3.6	V	
	Switch=On	V _S	0 to V _{CC}	٧	
Operating temperature		T _{opr}	-40 to 85	ç	
Input rise and fall time		dt/dv	0 to 10	ns/V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Input voltage "H" le	"H" level	V _{IH}	_	2.3 to 3.6	0.46 × V _{CC}	_	_	V
(\overline{OE})	"L" level	V _{IL}	_	2.3 to 3.6	_	_	0.25 × V _{CC}	V
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V	2.3 to 3.6	_	_	±1.0	μА
Power-off leakage current		l _{OFF}	V _{IN} = 0 to 3.6 V	0	_	_	±5.0	μΑ
Off-state leakage current (switch off)		I _{SZ}	$V_{IS} = 0$ to V_{CC} , $\overline{OE} = V_{CC}$	2.3 to 3.6	_	_	±5.0	μА
ON resistance (Note2)			$V_{IS} = 0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note	1) 3.0	_	4.5	9	
		RON	$V_{IS} = 0.4 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note	1) 3.0	_	5	9.5	Ω
			$V_{IS} = 3.0 \text{ V}, I_{IS} = 30 \text{ mA}$ (Note	1) 3.0	_	11	18	
Delta R _{ON} ΔR		ΔR _{ON}	V _{IS} = 0.4 V, 1.0V, I _{IS} = 30 mA	3.0	_	0.5	_	Ω
On-Resistance Flatness R		R _{ON(flat)}	V _{IN} = 0V to 1.0V, I _{IS} = 30 mA	3.0		1.2		Ω
Quiescent supply current		Icc	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	3.6	_	_	2.0	μΑ
Increase in I _{CC} per input		ΔI _{CC}	V _{IN} = 1.8V	3.6	_	_	10.0	μА

Note1: All typical values are at Ta = 25°C.

Note2: Measured by the voltage drop between D+/D- and HSD+/HSD- pins at the indicated current through the switch. ON resistance is determined by the lower of the voltages on the two pins.

AC Characteristics V_{CC} = 3.3V \pm 10% (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation Delay Time (Note)	tpd	C _L =5 pF	3.3 ± 0.3	_	0.25	_	ns
Turn ON Time (OE to Output)	t _{ON}	R _L =50 Ω, C _L =5 pF	3.3 ± 0.3		4	10	ns
Turn OFF Time (OE to Output)	tOFF	R _L =50 Ω, C _L =5 pF	3.3 ± 0.3	_	3.2	9	ns
Output skew between center port to any other port (Note)	t _{SK(O)}	C _L =5 pF	3.3 ± 0.3	_	0.1	_	ns
Skew of Opposite Transitions of the same output (tp _{HL} - tp _{LH}) (Note)	t _{SK(P)}	C _L =5 pF	3.3 ± 0.3	_	0.1	_	ns
Off Isolation (Non-Adjacent)	OIRR	R _T =50 Ω, f=240 MHz	3.3 ± 0.3	_	-27	_	dB
Crosstalk(Non-Adjacent)	XTalk	R _T =50 Ω, f=240 MHz	3.3 ± 0.3	_	-65	_	dB
-3dB Bandwidth	BW	R _T =50 Ω,C _L =0 pF	3.3 ± 0.3		1000		MHz

Note: This parameter is guaranteed by design.

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Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Тур.	Unit
Control pin input capaci tance ($\overline{\sf OE}$)	C _{IN}	V _{IN} = 0 V	(Note)	3.3	4	pF
Switch terminal Off capacitance	C _{I/O}	$V_{IS} = 0 V, \overline{OE} = V_{CC}$	(Note)	3.3	2.5	pF
Switch terminal On capacitance	C _{I/O}	$V_{IS} = 0 V, \overline{OE} = GND$	(Note)	3.3	5.5	pF

Note: This parameter is guaranteed by design.

AC Test Circuit Load / Waveform

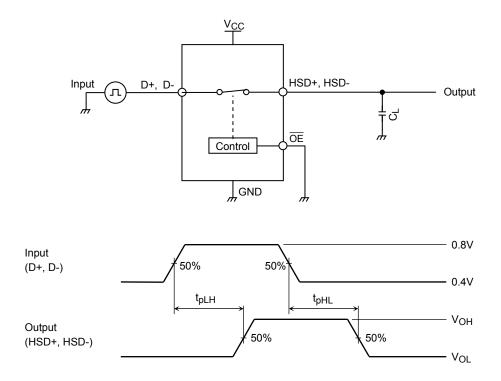


Figure 1 : Propagation Delay Time (t_{pLH}, t_{pHL})

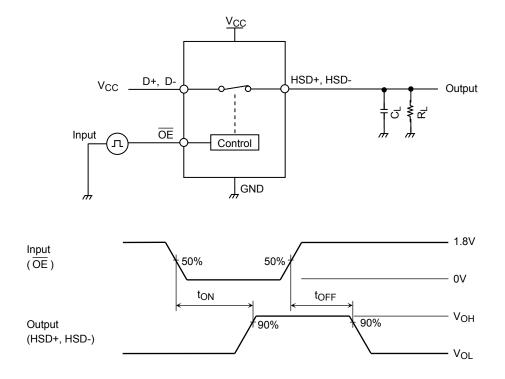
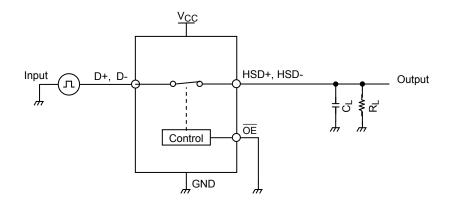
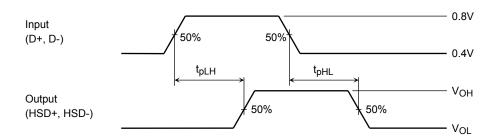
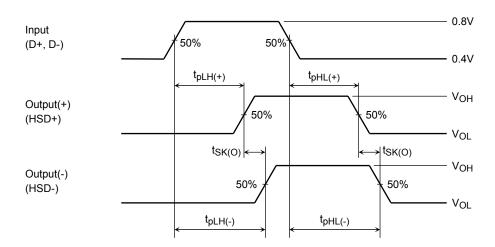


Figure 2: Turn ON/Turn OFF (ton, toff)





PULSE SKEW $t_{SK(P)} = |t_{pLH} - t_{pHL}|$



OUTPUT SKEW $t_{SK(O)} = |t_{pLH(+)} - t_{pLH(-)}| \text{ or } |t_{pHL(+)} - t_{pHL(-)}|$

Figure 3: Skew of Opposite Transitions of the same output, Output skew

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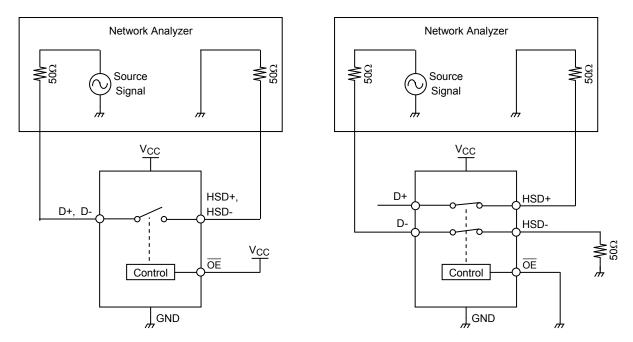


Figure 4 : Channel OFF Isolation

Figure 5 : Crosstalk

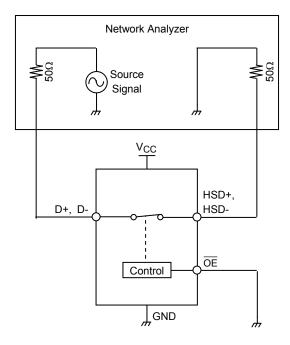


Figure 6: -3dB Bandwidth

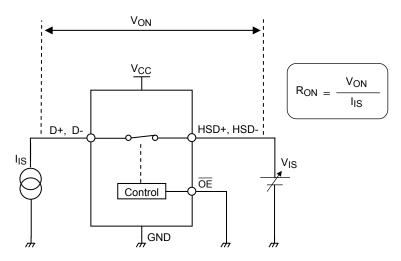


Figure 7: ON Resistance

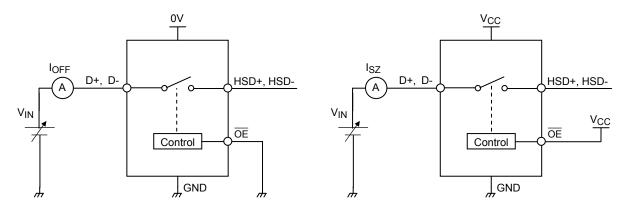


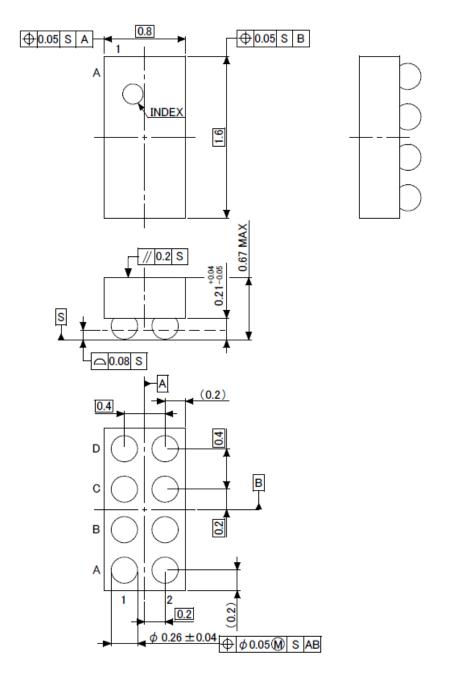
Figure 8 : Power off Leakage Current

Figure 9 : Off-State Leakage Current

Package Dimension

S-WFBGA8-0102-0.40A01

Unit: mm



The resin used in this product includes no flame retardants.

Weight: 0.0017 g (Typ.)

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